SPECIFICATION AMENDMENTS:

Please replace paragraph [0027] on page 9 of the specification with the following amended paragraph:

[0027] As discussed above, during imprinting template 26 and, therefore, mold 28 are brought into proximity with substrate 30 before patterning imprinting material ~~36a is disposed~~36a, disposed on a region 77. Specifically, template 26 is brought within tens of microns of substrate 30, e.g., 15 microns more or less. It has been found desirable to perform localized control of the atmosphere 78 that is proximate to both template 26 and region 77. For example, to avoid the deleterious effects of gases and/or gas pockets present in imprinting material 36a and/or subsequently trapped in the patterned imprinting layer 34, it has been found beneficial to control the consistency of fluid in atmosphere 78 and/or the pressure of atmosphere 78.

////
////
////
////
////
////
////
////
////
////
////